

ABSOLUTE MAXIMUM RATINGS

These are stress ratings only and functional operation of the device at these ratings or any other above those indicated in the operation sections of the specifications below is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

Input Voltage V _{IN}	0.3V to 6.6V
Enable V _{FB} Voltage	0.3V to V _{IN}
SW Voltage	$-0.3V$ to $(V_{IN}+0.3V)$
Peak Switch Sink/Source Current	1.3A
Junction Temperature	150°C
Storage Temperature	65°C to 150°C
Lead Temperature (Soldering, 10 sec)	260°C
ESD Rating (HBM - Human Body Mode	l) 2kV
ESD Rating (CDM - Charged Device Mo	odel)500V

OPERATING RATINGS

Input Voltage Range VIN	2.5V to 6.0V
Operating Temperature Range	40°C to 85°C
Operating Junction Temperature ¹	125°C
Thermal Resistance θ _{JA}	134.5°C/W
Thermal Resistance θ _{Jc}	81°C/W

Note 1: T_J is a function of the ambient temperature T_A and power dissipation P_D ($T_J = T_A + P_D \times \theta_{JA}$).

ELECTRICAL SPECIFICATIONS

Specifications with standard type are for an Operating Junction Temperature of $T_J = 25^{\circ}$ C only; limits applying over the full Operating Junction Temperature range are denoted by a "•". Minimum and Maximum limits are guaranteed through test, design, or statistical correlation. Typical values represent the most likely parametric norm at $T_A = 25^{\circ}$ C, and are provided for reference purposes only. Unless otherwise indicated, $V_{IN} = 3.6V$.

Parameter	Min.	Тур.	Max.	Units		Conditions
Feedback Current I _{VFB}			±30	nA		
Regulated Feedback Voltage V _{FB}	0.588	0.600	0.612	V	•	
Reference Voltage Line Regulation ΔV_{FB}			0.4	%/V	•	V _{IN} =2.5V to 5.5V
Output Over-Voltage Lockout ΔV _{OVL}	20	50	80	mV		$\Delta V_{OVL} = V_{OVL} - V_{FB} \text{ (Adj.)}$
Output Voltage Line Regulation ΔV _{ΟυΤ}			0.6	%/V	•	V _{IN} =2.5V to 5.5V
Peak Inductor Current IPK	1.2	2.3		Α		V _{IN} =3V, V _{FB} =0.5V
Output Voltage Load Regulation VLOADREG		0.5		%		
Quiescent Current ¹ I _Q		18		μΑ		V _{FB} =0.65V
Shutdown Current I _{SHTDWN}		0.1	1	μΑ		V _{EN} =0V, V _{IN} =4.2V
Oscillator Fraguency f	1.2	1.5	1.8	MHz	•	V _{FB} =0.6V
Oscillator Frequency fosc		750		kHz	•	V _{FB} =0V or V _{OUT} =0V
RDS(ON) of PMOS RPFET		0.24		Ω		I _{SW} =100mA
RDS(ON) of NMOS RNFET		0.24		Ω		I _{SW} =100mA
SW Leakage I _{LSW}			±1	μΑ		V _{EN} =0V, V _{SW} =0V or 5V, V _{IN} =5V
Enable Threshold V _{EN}			1.2	V	•	
Shutdown Threshold V _{EN}	0.4			V	•	
EN Leakage Current I _{EN}	_	_	±1	μΑ	•	

Note 1: The dynamic quiescent current is higher due to the gate charge being delivered at the switching frequency.



BLOCK DIAGRAM

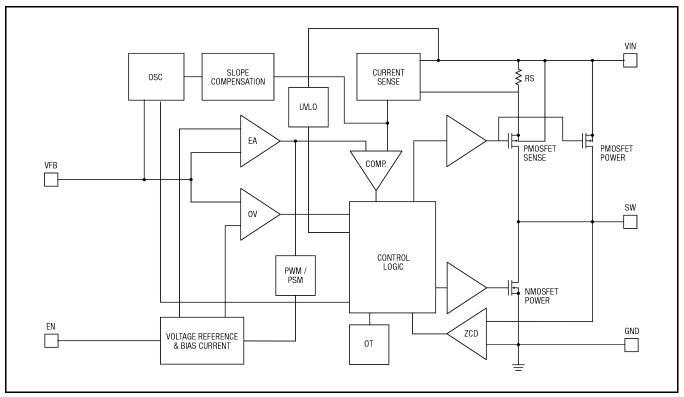


Fig. 2: SP6669 Block Diagram

PIN ASSIGNMENT

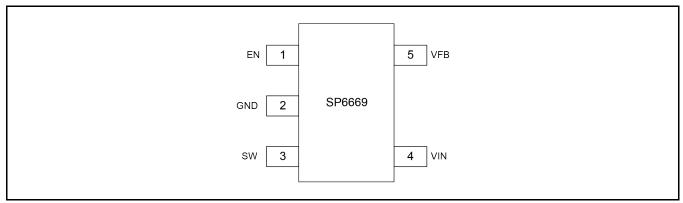


Fig. 3: SP6669 Pin Assignment



PIN DESCRIPTION

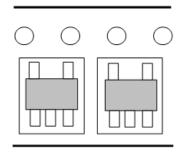
Name	Pin Number	Description			
EN	1	Enable Pin. Do not leave the pin floating. $V_{\text{EN}} < 0.4V$: Shutdown mode $V_{\text{EN}} > 1.2V$: Device enabled			
GND	2	Ground Signal			
SW	3	Switching Node			
VIN	4	Power Supply Pin. Must be decoupled to ground with a 4.7µF or greater ceramic capacitor.			
VFB	5	Feedback Input Pin. Connect VFB to the center point of the resistor divider.			

ORDERING INFORMATION

Part Number	Operating Temperature Range	Package	Packing Method	Lead-free	
SP6669AEK-L/TRR3	-40°C≤T _A ≤+85°C	SOT23-5	Tape & Reel	Yes	
SP6669EB	SP6669 Evaluation Board				

Note: for most up-to-date ordering information and additional information on environmental rating, go to $\underline{www.maxlinear.com/SP6669}$

Note that the SP6669 series is packaged in Tape and Reel with a reverse part orientation as per the following diagram





TYPICAL PERFORMANCE CHARACTERISTICS

All data taken at $V_{IN} = 2.7V$ to 5.5V, $T_J = T_A = 25$ °C, unless otherwise specified - Schematic and BOM from Application Information section of this datasheet.

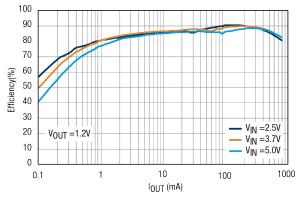


Fig. 4: Efficiency vs Output Current $V_{OUT} = 1.2V$

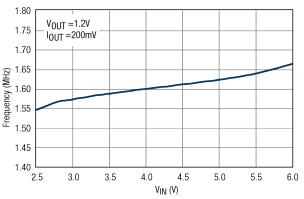


Fig. 5: Oscillator Frequency vs. Input Voltage

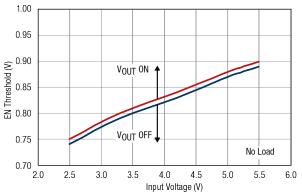


Fig. 6: EN Pin Threshold vs. Input Voltage

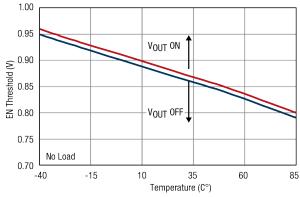


Fig. 7: EN Pin Threshold vs. Temperature

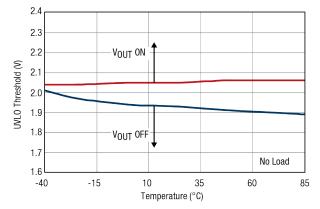


Fig. 8: UVLO Threshold vs. Temperature

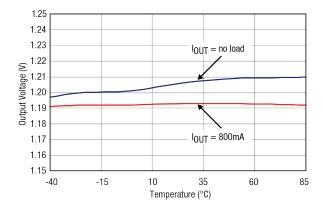


Fig. 9: Output Voltage vs Temperature



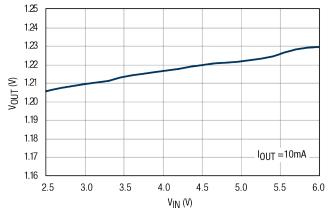


Fig. 10: Line Regulation

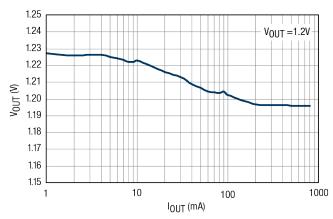


Fig. 11: Load Regulation

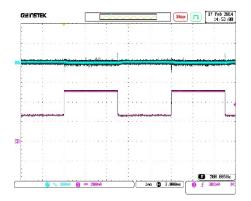


Fig. 12: Load Transient Response, Iout 250mA to 500mA, Vout = 1.2V

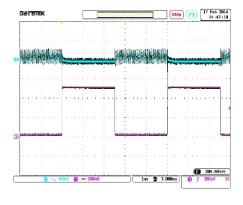


Fig. 13: Load Transient Response, Iout 10mA to 500mA, Vout = 1.2V

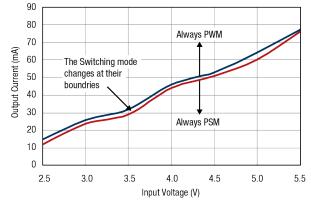


Fig. 14: PSM / PWM Boundaries

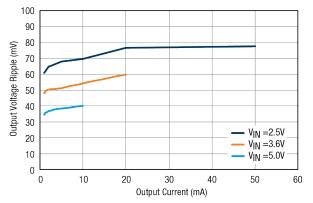


Fig. 15: Output Voltage Ripple vs Output Current



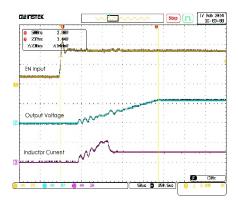


Fig. 16: Power-ON from EN Pin

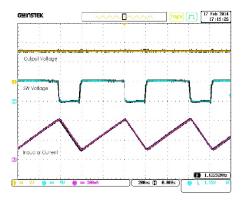


Fig. 18: PWM Operation

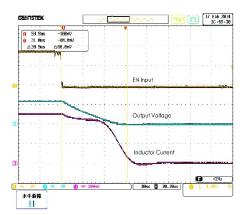


Fig. 17: Power-OFF from EN Pin

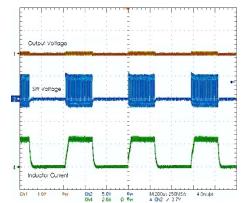


Fig. 19: Short Circuit Response



THEORY OF OPERATION

APPLICATIONS

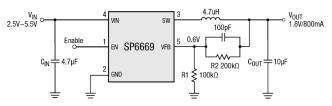


Fig. 20: Typical Application Circuit

INDUCTOR SELECTION

Inductor ripple current and core saturation are two factors considered to select the inductor value.

Eq. 1:
$$\Delta I_L = \frac{1}{f \cdot L} V_{OUT} \left(1 - \frac{V_{OUT}}{V_{IN}} \right)$$

Equation 1 shows the inductor ripple current as a function of the frequency, inductance, V_{IN} and V_{OUT} . It is recommended to set the ripple current between 30% to 40% of the maximum load current. A low ESR inductor is preferred.

CIN AND COUT SELECTION

A low ESR input capacitor can prevent large voltage transients at $V_{\rm IN}$. The RMS current rating of the input capacitor is required to be larger than $I_{\rm RMS}$ calculated by:

Eq. 2:
$$I_{\rm RMS} \cong I_{\rm OMAX} \, \frac{\sqrt{V_{\rm OUT} \big(V_{\rm IN} - V_{\rm OUT}\big)}}{V_{\rm IN}}$$

The ESR rating of the capacitor is an important parameter to select C_{OUT} . The output ripple V_{OUT} is determined by:

Eq. 3:
$$\Delta V_{OUT} \cong \Delta I_L \left(ESR + \frac{1}{8 \cdot f \cdot C_{OUT}} \right)$$

Higher values, lower cost ceramic capacitors are now available in smaller sizes. These capacitors have high ripple currents, high voltage ratings and low ESR that makes them ideal for switching regulator applications. As C_{OUT} does not affect the internal control loop

stability, its value can be optimized to balance very low output ripple and circuit size. It is recommended to use an X5R or X7R rated capacitors which have the best temperature and voltage characteristics of all the ceramics for a given value and size.

SETTING OUTPUT VOLTAGE

The output voltage is determined by:

Eq. 4:
$$V_{OUT} = 0.6V \cdot \left(1 + \frac{R_2}{R_1}\right)$$

THERMAL CONSIDERATIONS

Although the SP6669 has an on board over temperature circuitry, the total power dissipation it can support is based on the package thermal capabilities. The formula to ensure safe operation is given in note 1.

PCB LAYOUT

The following PCB layout guidelines should be taken into account to ensure proper operation and performance of the SP6669:

- 1- The GND, SW and V_{IN} traces should be kept short, direct and wide.
- 2- V_{FB} pin must be connected directly to the feedback resistors. The resistor divider network must be connected in parallel to the C_{OUT} capacitor.
- 3- The input capacitor C_{IN} must be kept as close as possible to the V_{IN} pin.
- 4- The SW and VFB nodes should be kept as separate as possible to minimize possible effects from the high frequency and voltage swings of the SW node.
- 5- The ground plates of C_{IN} and C_{OUT} should be kept as close as possible.



OUTPUT VOLTAGE RIPPLE FOR V_{IN} CLOSE TO V_{OUT}

When the input voltage $V_{\rm IN}$ is close to the output voltage $V_{\rm OUT}$, the SP6669 transitions smoothly from the switching PWM converter mode into a LDO mode. The following diagram shows the output voltage ripple versus the input voltage for a 3.3V output setting and a 200mA current load.

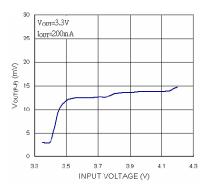


Fig. 20: VOUT Ripple Voltage for VIN decreasing close to V_{OUT}

DESIGN EXAMPLE

In a single Lithium-Ion battery powered application, the V_{IN} range is about 2.7V to 4.2V. The desired output voltage is 1.8V.

The inductor value needed can be calculated using the following equation

$$L = \frac{1}{f \cdot \Delta I_L} V_{OUT} \left(1 - \frac{V_{OUT}}{V_{IN}} \right)$$

Substituting V_{OUT} =1.8V, V_{IN} =4.2V, ΔI_L =180mA to 240mA (30% to 40%) and f=1.3MHz gives

$$L = 2.86 \mu H \text{ to } 3.81 \mu H$$

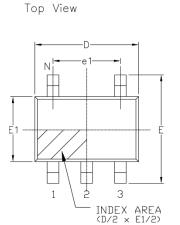
A 3.3 μ H inductor can be chosen with this application. An inductor of greater value with less equivalent series resistance would provide better efficiency. The CIN capacitor requires an RMS current rating of at least $I_{LOAD(MAX)}/2$ and low ESR. In most cases, a ceramic capacitor will satisfy this requirement.

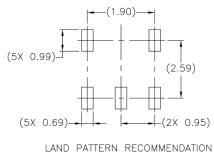


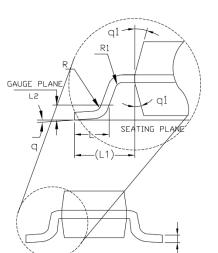
MECHANICAL DIMENSIONS

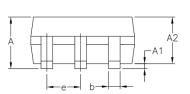
5-PIN SOT23

FOR REFERENCE ONLY









Side View

Front View

5 Pin SOT-23 JEDEC MO-178 Variation AA						
SYMBOLS	DIMENSIONS IN MM (Control Unit)			DIMENSIONS IN INCH (Reference Unit)		
	MIN	NOM	MAX	MIN NOM		MAX
А	_	_	1.45	_	_	0.057
A1	0.00	_	0.15	0.000	_	0.006
A2	0.90	1.15	1.30	0.036	0.045	0.051
b	0.30	_	0.50	0.012	_	0.020
С	0.08	_	0.22	0.003	_	0.009
D	2	.90 BS	SC .	С).115 B	SC
E	2	.80 BS	SC .	0.111 BSC		
E1	1	.60 BS	SC .	0.063 BSC		
е	C).95 BS	C C	0.038 BSC		
e1	1	.90 BS	SC .	0.075 BSC		
L	0.30	0.45	0.60	0.012 0.018 0.		0.024
L1	().60 RE	F	0.	.024 RE	F
L2	0.25 BSC			0.	.010 BS	C
R	0.10	_	—	0.004	_	_
R1	0.10		0.25	0.004	_	0.010
q	0,	4*	8*	0,	4*	8*
q1	5°	10°	15°	5*	10°	15°
N		5			5	

Drawing No: POD-00000025 Revision: B



REVISION HISTORY

Revision	Date	Description
2.0.0	07/15/2011	Reformat of datasheet Updated package specification
2.1.0	02/07/2012	Updated Typical Application schematics and Design example
2.2.0	11/08/2012	Reformat of datasheet (New logo) Updated Absolute Maximum Ratings, Lead Temperature (Soldering, 10 sec) to 260°C
2.2.1	05/13/2016	Reformat of datasheet (New logo) Changed oscillator frequency unit
3.0.0	12/07/2017	Updated I_{OUT} , V_{IN} range, thermal resistance, ΔV_{OUT} , V_{FB} temperature condition, I_{PK} , I_Q , f_{OSC} , $R_{DS(ON)}$, package drawing (now Mechanical Dimensions), format and Ordering Information. Added PSM and new graphs. Updated to MaxLinear logo. Removed fixed voltage options. New graphs.
4.0.0	01/07/2020	Updated I_{OUT} , V_{IN} range and V_{IN} absolute max, I_{Q} , I_{PK} , $R_{\text{DS(ON)}}$. Updated graphs. Updated ESD rating.
5.0.0	07/26/2021	Updated I_{OUT} , V_{IN} range and V_{IN} absolute max, I_{Q} , I_{PK} , $R_{\text{DS(ON)}}$. Updated graphs. Updated ESD rating. PCN 19011A (Addendum) cancels rev 4.0.0, therefore rev 5.0.0 is the same as rev 3.0.0.



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